

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Freywald
Serial No. : 10/588,415
Filed : 07/14/2008
International Filing Date : 02/05/2005
Title : FILLING OF INSULATION TRENCHES USING CMOS-
STANDARD PROCESSES FOR CREATING
DIELECTRICALLY INSULATED AREAS ON A SOI DISK
Attorney Docket : LEO 009 PA
Examiner : Nguyen, Thinh T
Art Unit : 2818
Confirmation No. : 8357

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

This paper is being filed in response to the Office Action mailed August 9, 2010. Reconsideration is respectfully requested in view of the amendments and remarks below. A request for a two month extension of time is being filed concurrently herewith.

Amendments to the Claims are reflected in the listing of claims, which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.